

# Single P-channel MOSFET

ELM34419AA-N

## General description

ELM34419AA-N uses advanced trench technology to provide excellent  $R_{ds(on)}$ , low gate charge and low gate resistance.

## Features

- $V_{ds} = -30V$
- $I_d = -10A$
- $R_{ds(on)} < 20m\Omega$  ( $V_{gs} = -10V$ )
- $R_{ds(on)} < 35m\Omega$  ( $V_{gs} = -4.5V$ )

## Maximum absolute ratings

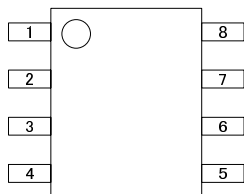
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	$V_{ds}$	-30	V		
Gate-source voltage	$V_{gs}$	$\pm 25$	V		
Continuous drain current	$I_d$	$T_a = 25^\circ C$	-10	A	
		$T_a = 70^\circ C$	-8		
Pulsed drain current	$I_{dm}$	-55	A	3	
Avalanche current	$I_{ar}$	-29	A		
Avalanche energy	$L = 0.1mH$	Eas	43	mJ	
Power dissipation	$P_d$	$T_a = 25^\circ C$	3	W	
		$T_a = 70^\circ C$	2		
Junction and storage temperature range	$T_j, T_{stg}$	-55 to 150	$^\circ C$		

## Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-case	$R\theta_{jc}$		25	$^\circ C/W$	
Maximum junction-to-ambient	$R\theta_{ja}$		40	$^\circ C/W$	

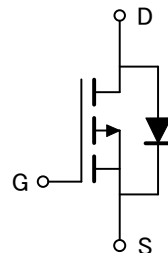
## Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

## Circuit



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## ■ Electrical characteristics

Ta=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
<b>STATIC PARAMETERS</b>							
Drain-source breakdown voltage	BVdss	Id=-250μA, Vgs=0V	-30			V	
Zero gate voltage drain current	Idss	Vds=-24V, Vgs=0V			-1	μA	
		Vds=-20V, Vgs=0V, Tj=125°C			-10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±25V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250μA	-1.0	-1.5	-3.0	V	
Static drain-source on-resistance	Rds(on)	Vgs=-10V, Id=-10A		15	20	mΩ	1
		Vgs=-4.5V, Id=-7A		25	35	mΩ	
Forward transconductance	Gfs	Vds=-10V, Id=-10A		24		S	1
Diode forward voltage	Vsd	Is=-1A, Vgs=0V			-1.2	V	1
Max. body-diode continuous current	Is				-2.5	A	
<b>DYNAMIC PARAMETERS</b>							
Input capacitance	Ciss			1490		pF	
Output capacitance	Coss	Vgs=0V, Vds=-15V, f=1MHz		301		pF	
Reverse transfer capacitance	Crss			190		pF	
Gate resistance	Rg	Vgs=15mV, Vds=0V, f=1MHz		7.8	9.0	Ω	
<b>SWITCHING PARAMETERS</b>							
Total gate charge	Qg	Vgs=-10V, Vds=-15V Id=-10A		26		nC	2
Gate-source charge	Qgs			4		nC	2
Gate-drain charge	Qgd			5		nC	2
Turn-on delay time	td(on)	Vgs=-10V, Vds=-15V Id ≈ -1A, Rgen=6Ω		5.7		ns	2
Turn-on rise time	tr			10.0		ns	2
Turn-off delay time	td(off)			18.0		ns	2
Turn-off fall time	tf			5.0		ns	2

NOTE :

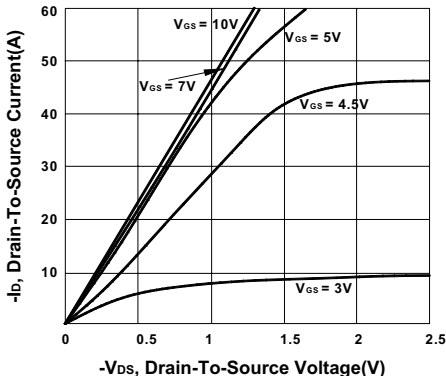
1. Pulsed width ≤ 300μsec and Duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulsed width limited by maximum junction temperature.
4. Duty cycle ≤ 1%.

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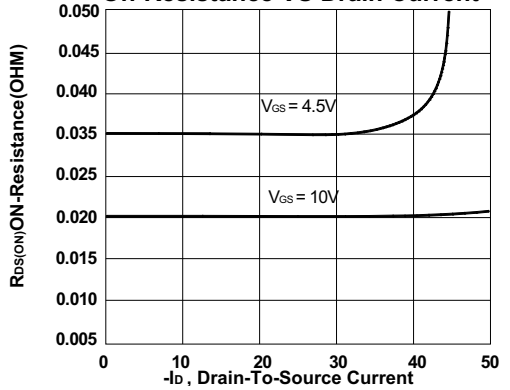
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## Typical electrical and thermal characteristics

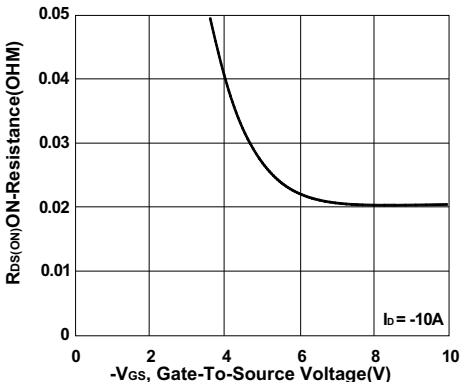
### Output Characteristics



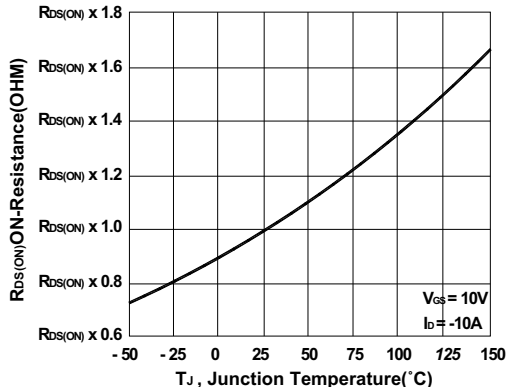
### On-Resistance VS Drain Current



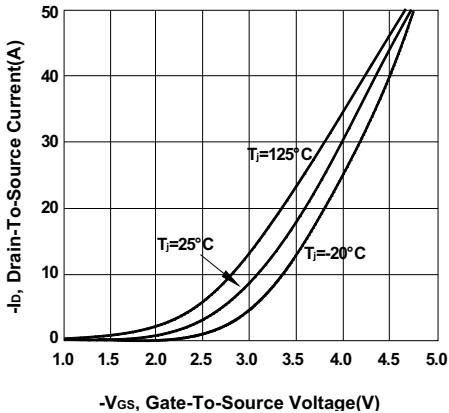
### On-Resistance VS Gate-To-Source



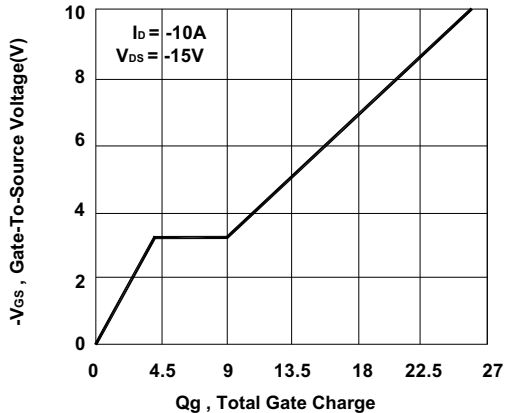
### On-Resistance VS Drain Current



### Transfer Characteristics



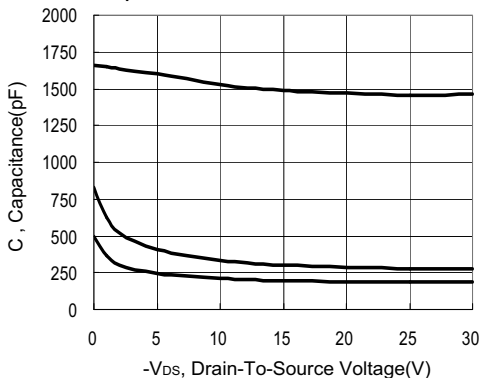
### Gate charge Characteristics



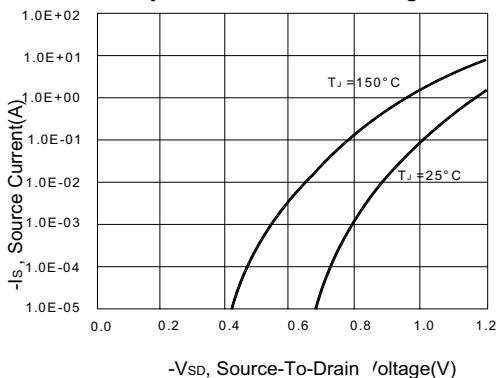
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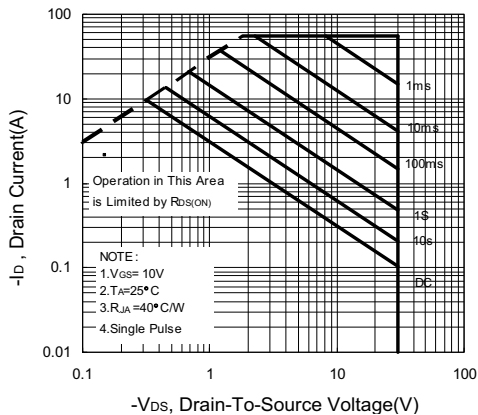
### Capacitance Characteristic



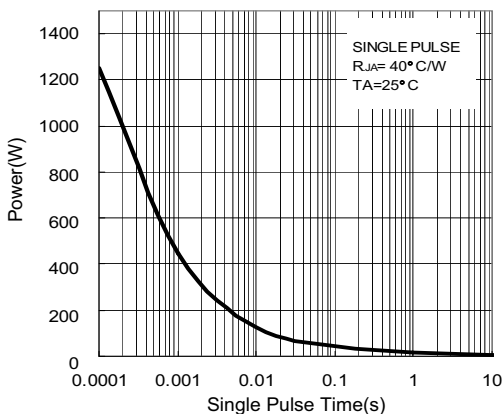
### Body Diode Forward Voltage



### Safe Operating Area



### Single Pulse Maximum Power Dissipation



### Transient Thermal Response Curve

